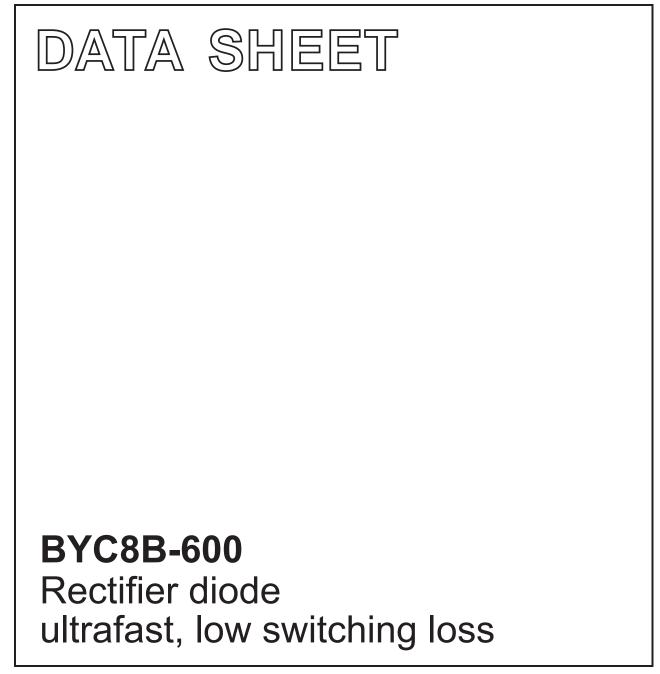
DISCRETE SEMICONDUCTORS



Product specification

March 2001



# **BYC8B-600**

# **FEATURES**

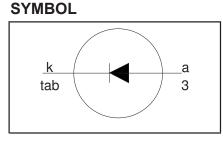
- Extremely fast switching
- Low reverse recovery current
- Low thermal resistance
- Reduces switching losses in associated MOSFET

### **APPLICATIONS**

- Active power factor correction
- Half-bridge lighting ballastsHalf-bridge/ full-bridge switched

mode power supplies.

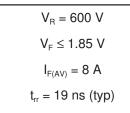
The BYC8B-600 is supplied in the SOT404 surface mounting package.



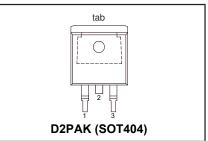
### PINNING

DESCRIPTION		
no connection		
cathode <sup>1</sup>		
anode		
cathode		

### QUICK REFERENCE DATA



# **SOT404**



# LIMITING VALUES

Limiting values in accordance with the Absolute Maximum System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V <sub>RRM</sub>	Peak repetitive reverse voltage		-	600	V
V <sub>RWM</sub>	Crest working reverse voltage		-	600	V
V <sub>R</sub>	Continuous reverse voltage	$T_{mb} \leq 110 \degree C$	-	500	V
I <sub>F(AV)</sub>	Average forward current	$\delta = 0.5$ ; with reapplied V <sub>RRM(max)</sub> ;	-	8	A
I <sub>FRM</sub>	Repetitive peak forward current	$ \begin{array}{l} T_{mb} \leq 82 \ ^{\circ}C \\ \delta = 0.5; \mbox{ with reapplied } V_{RRM(max)}; \\ T_{mb} \leq 82 \ ^{\circ}C \end{array} $	-	16	A
I <sub>FSM</sub>	Non-repetitive peak forward	t = 10  ms	-	55	A
	current.	t = 8.3 ms sinusoidal; T <sub>i</sub> = 150°C prior to surge	-	60	A
_		with reapplied V <sub>RWM(max)</sub>		. – .	
<u>T</u> <sub>stg</sub>	Storage temperature		-40	150	°C
T <sub>i</sub>	Operating junction temperature		-	150	O°

#### THERMAL RESISTANCES

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
R <sub>th j-mb</sub>	Thermal resistance junction to		-	-	2.2	K/W
R <sub>th j-a</sub>	mounting base Thermal resistance junction to ambient	minimum footprint, FR4 board	-	50	-	K/W

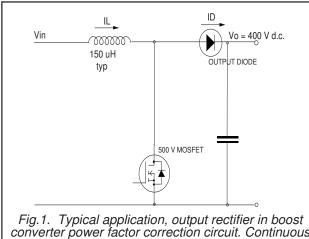
<sup>1</sup> it is not possible to make connection to pin 2 of the SOT404 package

# BYC8B-600

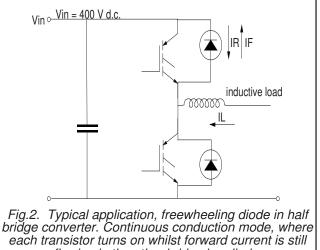
#### **ELECTRICAL CHARACTERISTICS**

 $T_i = 25$  °C unless otherwise stated

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V <sub>F</sub>	Forward voltage	I <sub>F</sub> = 8 A; Τ <sub>i</sub> = 150°C	-	1.4	1.85	V
		$I_{F} = 16 \text{ Å}; T_{j} = 150^{\circ}\text{C}$	-	1.7	2.3	V
1_	Reverse current	I <sub>F</sub> = 8 A; V <sub>B</sub> = 600 V	-	2.0 9	2.9 150	ν μA
I <sub>R</sub>		$V_{R} = 500 V; T_{j} = 100 °C$	-	1.1	3.0	mΑ
t <sub>rr</sub>	Reverse recovery time	$I_{\rm F} = 1 \text{ A}; V_{\rm B} = 30 \text{ V}; dI_{\rm F}/dt = 50 \text{ A}/\mu\text{s}$	-	30	52	ns
t <sub>rr</sub>	Reverse recovery time	$I_{\rm F} = 8 \text{ A}; V_{\rm R} = 400 \text{ V};$	-	19	-	ns
t <sub>rr</sub>	Reverse recovery time	dI <sub>F</sub> /dt = 500 A/µs I <sub>F</sub> = 8 A; V <sub>R</sub> = 400 V; dI <sub>F</sub> /dt = 500 A/µs; T <sub>j</sub> = 100°C	-	32	40	ns
I <sub>rrm</sub>	Peak reverse recovery current	I <sub>F</sub> = 8 A; V <sub>R</sub> = 400 V; dI <sub>F</sub> /dt = 50 A/μs; T <sub>i</sub> = 125°C	-	1.5	5.5	А
l <sub>rrm</sub>	Peak reverse recovery current	$dI_{F}/dt = 50 A/\mu s, T_{j} = 125 C$ $I_{F} = 8 A; V_{R} = 400 V;$ $dI_{F}/dt = 500 A/\mu s; T_{j} = 125 °C$	-	9.5	12	А
V <sub>fr</sub>	Forward recovery voltage	$I_F = 10 \text{ A}; dI_F/dt = 100 \text{ A}/\mu\text{s}$	-	8	10	V

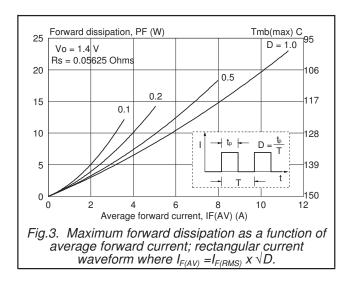


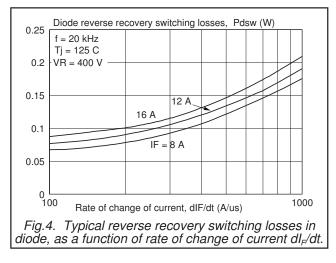
converter power factor correction circuit. Continuous conduction, mode where the transistor turns on whilst forward current is still flowing in the diode.

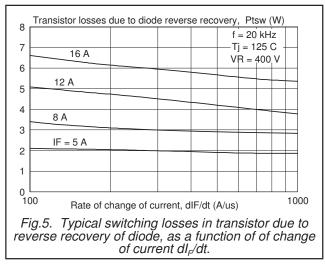


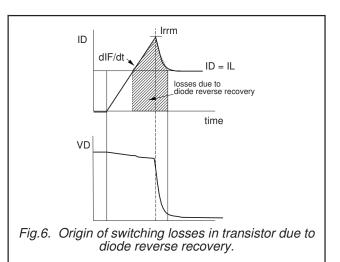
flowing in the other bridge leg diode.

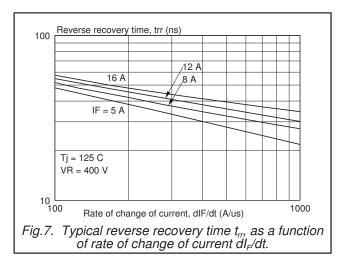
# BYC8B-600

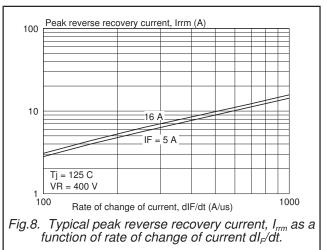




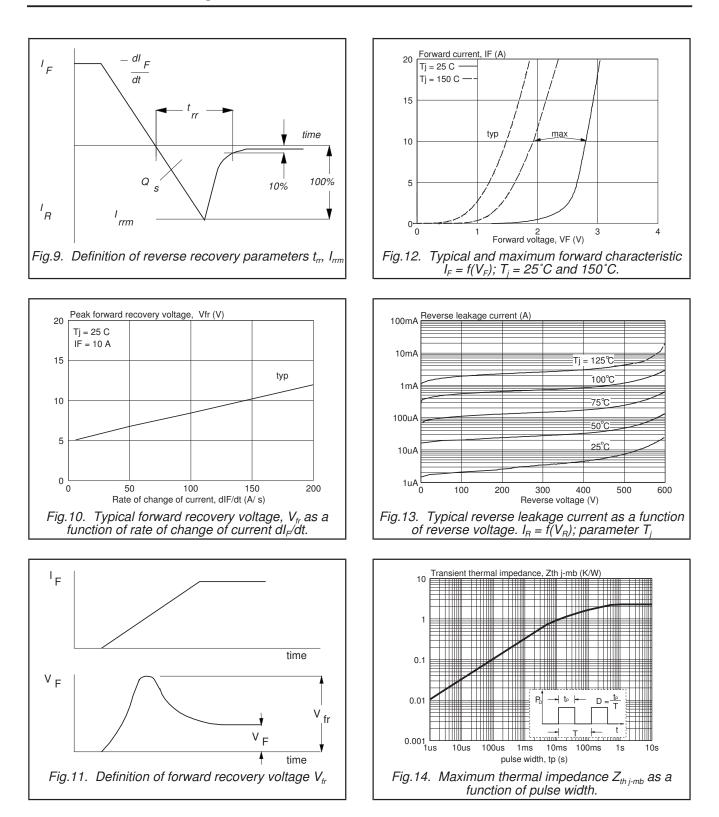






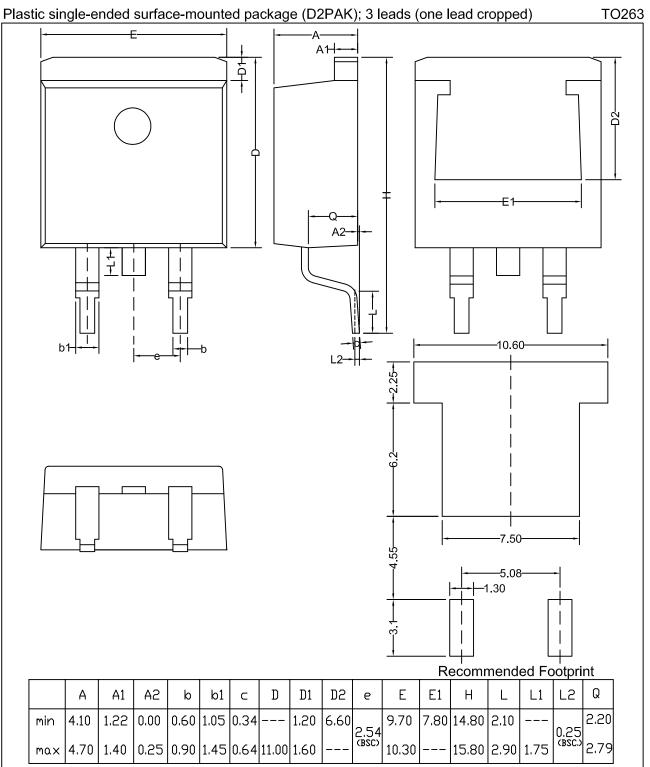


BYC8B-600



# BYC8B-600

# **MECHANICAL DATA**



# Legal information

#### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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- [2] The term 'short data sheet' is explained in section "Definitions".
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